THE DATASHEET OF

WND08P16DJ

WND08P16D

Standard power diode

Rev.01 - 1 August 2018 Product data sheet

1. General description

Standard reverse recovery power diode in a TO252 package.

2. Features and benefits

- Low forward voltage drop
- Low leakage current
- High voltage capability
- High inrush current capability

3. Applications

- Input rectifier
- Bypass diode

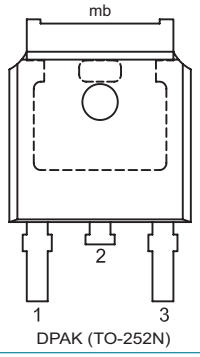
4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Values				Unit
Absolute maximum rating							
V_{RRM}	repetitive peak reverse voltage		1600				V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; $T_{mb} \leq 139$ °C; Fig. 1; Fig. 2; Fig. 3	8				A
I_{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	150				A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse;	165				A
Symbol	**Parameter**	**Conditions**		**Min**	**Typ**	**Max**	**Unit**
Static characteristics							
V_F	forward voltage	I_F = 8 A; T_j = 25 °C; Fig. 6		-	1.05	1.25	V
		I_F = 8 A; T_j = 150 °C; Fig. 6		-	0.95	1.15	V

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A	anode	 DPAK (TO-252N)	*001aaa020*
2	K	cathode [1]		
3	A	anode		
mb	K	mounting base; connected to cathode		

[1] It is not possible to connect to pin 2 of the TO252 package.

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
WND08P16D	DPAK	plastic single-ended surface-mounted package (DPAK); 3 leads (one lead cropped)	TO-252N

7. Marking

Table 4. Marking codes

Type number	Marking codes
WND08P16D	D08P16

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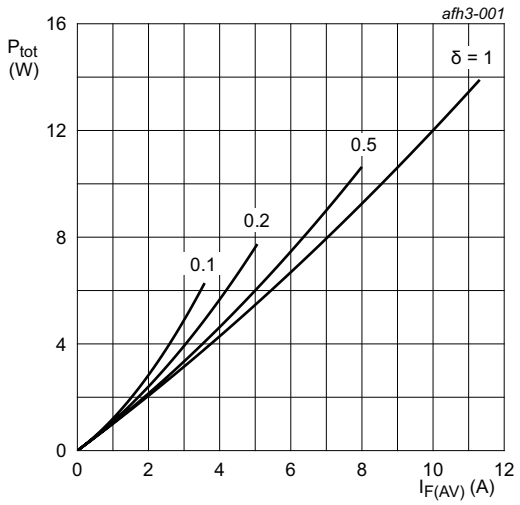
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

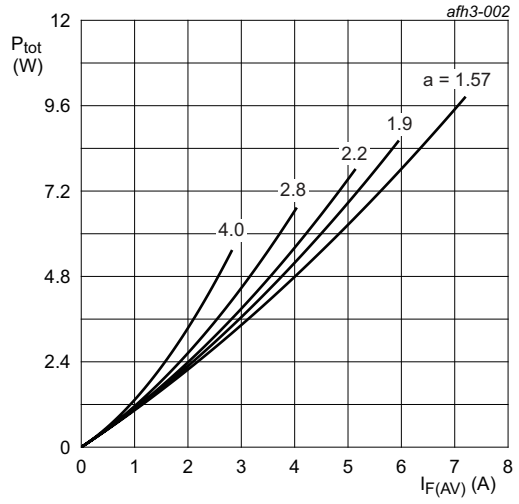
Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		1600	V
V_{RWM}	crest working reverse voltage		1600	V
V_R	reverse voltage	DC	1600	V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; $T_{mb} \leq 139$ °C; Fig. 1; Fig. 2; Fig. 3	8	A
I_{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	150	A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse;	165	A
T_{stg}	storage temperature		-55 to 150	°C
T_j	junction temperature		150	°C



$I_{F(AV)} = I_{F(RMS)} \times \sqrt{\delta}$

V_o = 0.985 V; R_s = 0.0215 Ω

Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values



a = form factor = $I_{F(RMS)} / I_{F(AV)}$

Vo = 0.985 V; Rs = 0.0215 Ω

Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

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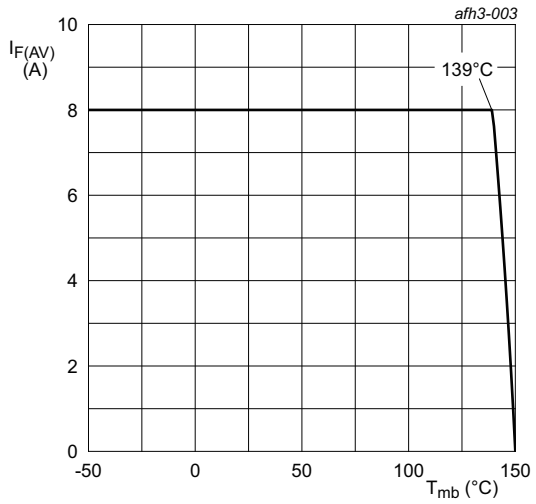

Fig. 3. Forward current as a function of mounting base temperature; maximum values

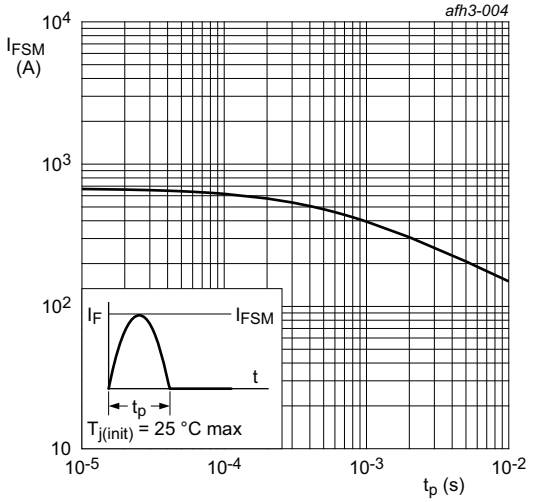

Fig. 4. Non-repetitive peak forward current as a function of pulse width; sinusoidal waveform; maximum values

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9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	Fig. 5		-	-	1	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient free air	in free air		-	60	-	K/W

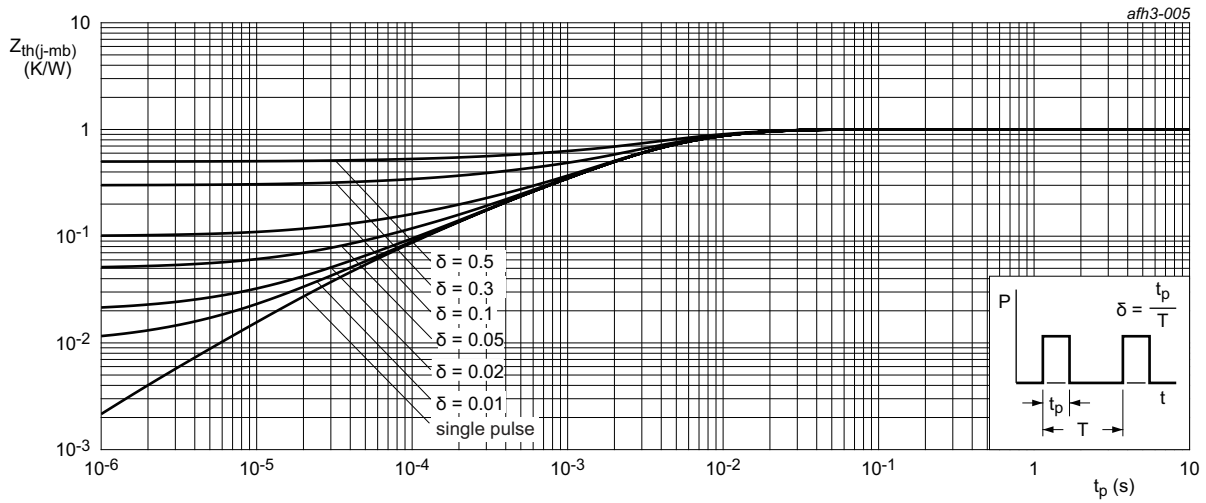

Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration

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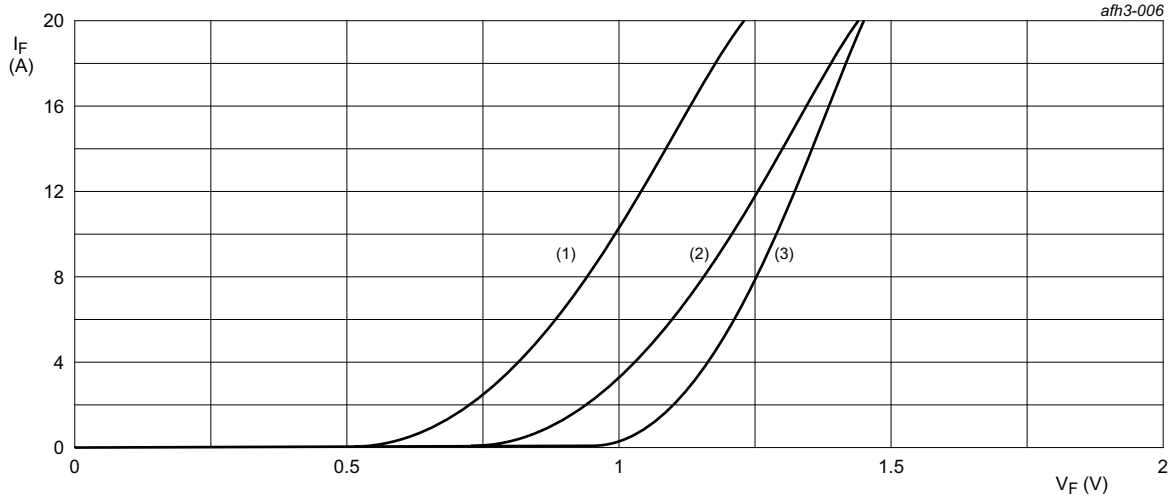
10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Static characteristics							
V_F	forward current	I_F = 8 A; T_j = 25 °C; Fig. 6		-	1.05	1.25	V
		I_F = 8 A; T_j = 150 °C; Fig. 6		-	0.95	1.15	V
I_R	reverse current	V_R = 1600 V; T_j = 25 °C		-	-	50	µA
		V_R = 1600 V; T_j = 150 °C		-	-	1.5	mA



V_o = 0.985 V; R_s = 0.0215 Ω
(1) T_j = 150 °C; typical values
(2) T_j = 150 °C; maximum values
(3) T_j = 25 °C; maximum values

Fig. 6. Forward current as a function of forward voltage

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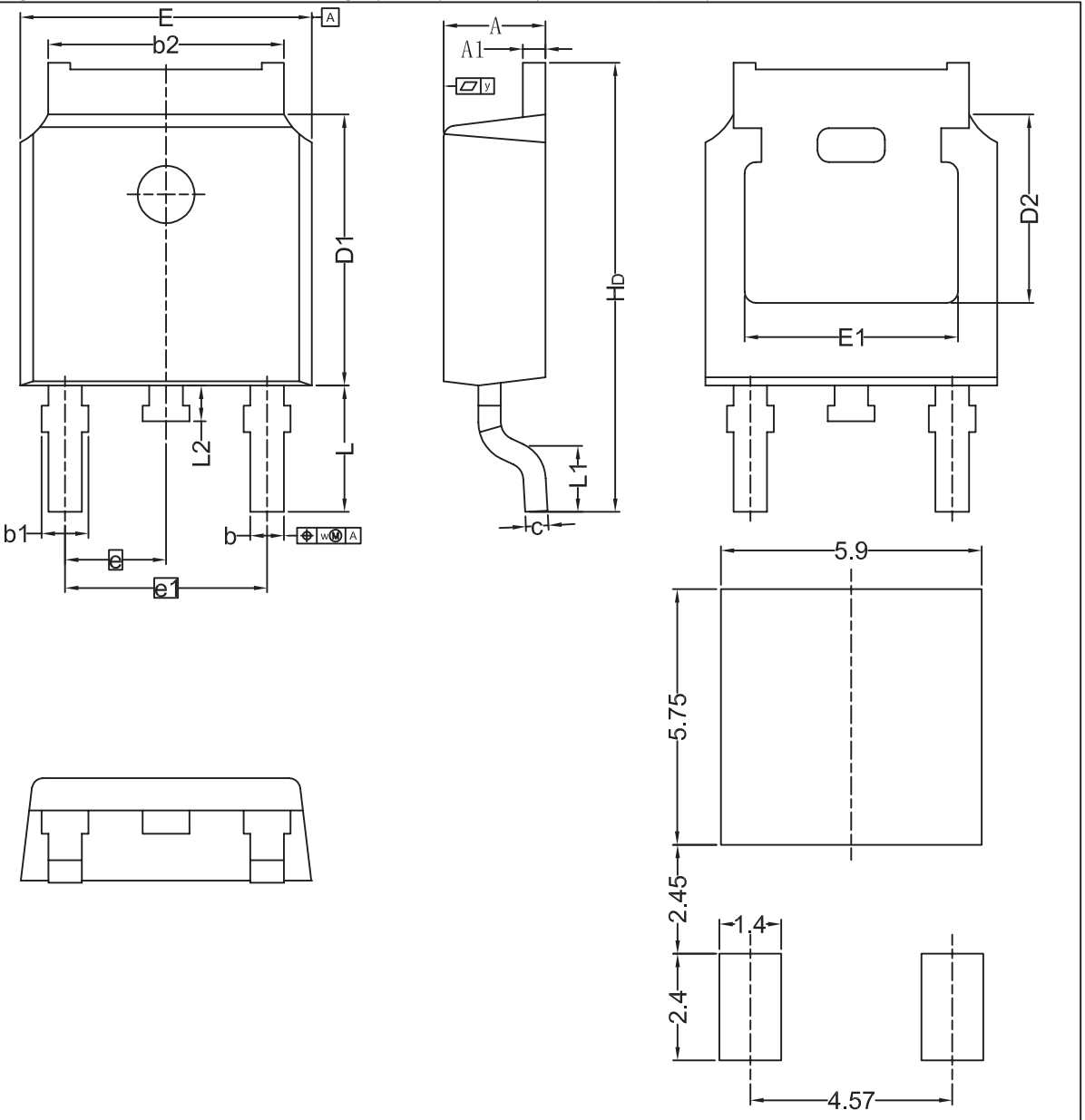
11. Package outline

Plastic single-ended surface-mounted package (DPAK); 3 leads (one lead cropped) TO252



Recommended Footprint

Unit	A	A1	b	b1	b2	c	D1	D2	E	E1	e	e1	H_D	L	L1	L2	w	y
min	2.22	0.46	0.71	0.72	5.00	0.20	5.98	4.00	6.47	4.45	2.285	4.57	9.60	2.90 (Ref.)	0.50	0.50	0.20	
mm nom																		
max	2.38	0.93	0.89	1.10	5.46	0.56	6.22	---	6.73	---			10.40		---	0.90		0.20

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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13. Contents

1. General description 1
2. Features and benefits 1
3. Applications 1
4. Quick reference data 1
5. Pinning information 2
6. Ordering information 2
7. Marking 2
8. Limiting values 3
9. Thermal characteristics 5
10. Characteristics 6
11. Package outline 7
12. Legal information 8
13. Contents 10

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